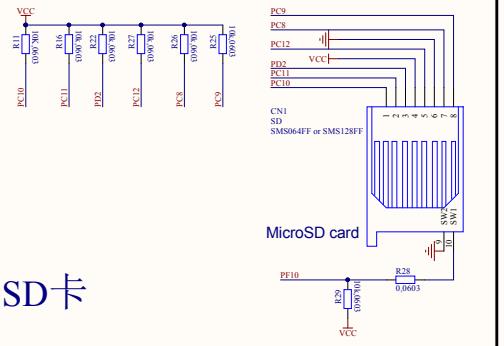
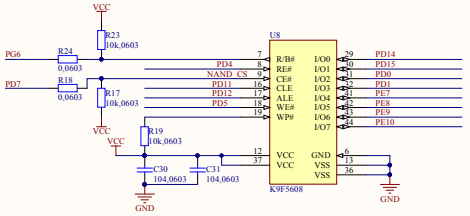
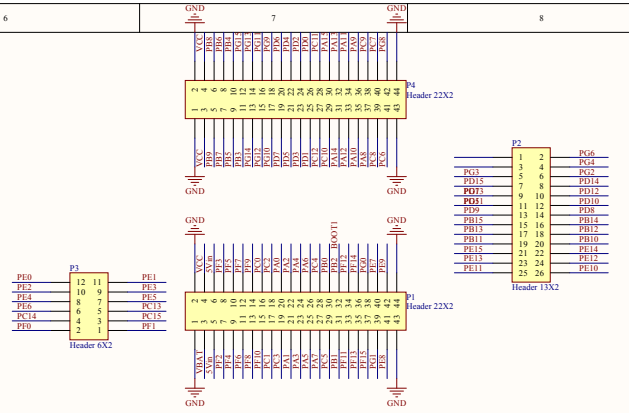
SD卡



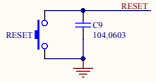
NandFlash



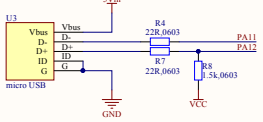
对外I/O口



复位按键

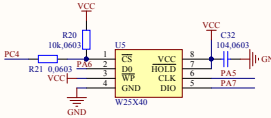


USB接口

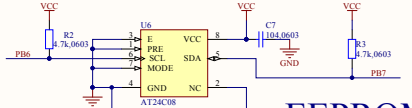


J-Link调试接口

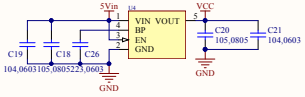
SPI Flash



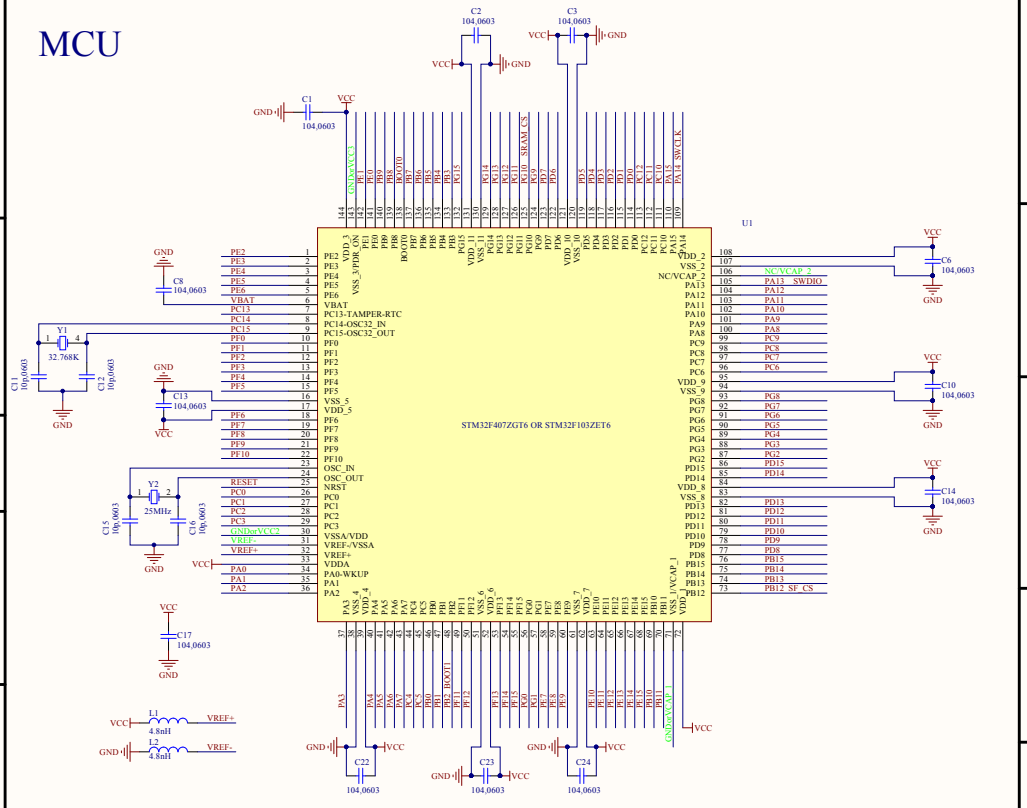
EEPROM



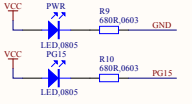
LDO（5V-->3.3V）



MCU

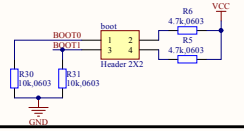


LED指示灯



BOOTx设置

BOOT1	BOOT0	MODE
X	0	FLASH
1	1	SRAM
0	1	ISP



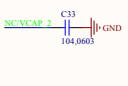
STM32F407ZGT6mini核心板原理图
OR
STM32F103ZET6mini核心板原理图

源地工作室www.vcc-gnd.com

源地网店http://vcc-gnd.taobao.com/

注释：R15和R14焊接时，二选其一
作为STM32F103ZET6MINI时焊接R15/0R/0603
作为STM32F407ZGT6MINI时焊接R14/0R/0603

注释：R12和R13焊接时，二选其一
作为STM32F103ZET6MINI时焊接R13/0R/0603
作为STM32F407ZGT6MINI时焊接R12/0R/0603



注释：
作为STM32F103ZET6MINI时，C33不焊接
作为STM32F407ZGT6MINI时，C33焊接贴片陶瓷电容104/0603

注释：
作为STM32F103ZET6MINI时，C28焊接贴片电阻0R/0603
作为STM32F407ZGT6MINI时，C28焊接贴片陶瓷电容104/0603

注释：
STM32F103ZET6和STM32F407ZGT6两个MCU引脚基本兼容，个别除外，详情参考技术手册

Title		
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Date: 2016/5/12		Sheet of
File: E:\济南源地仪器设备有限公司\...\STM32F103ZE(407ZE)T6Mini核心板.SchDoc		